

EcoSPARK® 3 Ignition IGBT 200 mJ, 400 V, N-Channel Ignition IGBT

FGD2040G3-F085

Features

- SCIS Energy = 200 mJ at $T_J = 25^{\circ}C$
- Low Saturation Voltage
- Logic Level Gate Drive
- AEC-Q101 Qualified and PPAP Capable
- RoHS Compliant

Applications

- Automotive Ignition Coil Driver Circuits
- High Current Ignition System
- Coil on Plug Applications

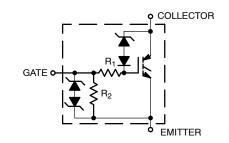
MAXIMUM RATINGS (T_J = 25°C unless otherwise stated)

Symbol	Parameter	Value	Units
BV _{CER}	Collector-to-Emitter Breakdown Voltage (I _C = 1 mA)	400	V
BV _{ECS}	Emitter-to-Collector Voltage - Reverse Battery Condition (I _C = 10 mA)	28	V
E _{SCIS25}	ISCIS = 11.5 A, L = 3.0 mHy, R_{GE} = 1 K Ω , T_{C} = 25°C (Note 1)	200	mJ
E _{SCIS150}	ISCIS = 9.1 A, L = 3.0 mHy, R_{GE} = 1 K Ω , T_{C} = 150°C (Note 2)		mJ
I _{C25}	Collector Current Continuous at $V_{GE} = 5.0 \text{ V}$, $T_C = 25^{\circ}\text{C}$	23.6	Α
I _{C110}	I_{C110} Collector Current Continuous at $V_{GE} = 5.0 \text{ V}$, $T_{C} = 110^{\circ}\text{C}$		Α
V_{GEM}	GEM Gate-to-Emitter Voltage Continuous		V
P _D	Power Dissipation Total, T _C = 25°C	125	W
	Power Dissipation Derating, $T_C > 25^{\circ}C$	0.83	W/°C
T _J , T _{STG}	J, T _{STG} Operating Junction and Storage Temperature Range		°C
TL	T _L Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		°C
T _{PKG}	PKG Reflow soldering according to JESD020C		°C
ESD	HBM – Electrostatic Discharge Voltage at 100 pF, 1500 Ω	4	kV
	CDM – Electrostatic Discharge Voltage at 1 Ω	2	kV

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Self Clamped inductive Switching Energy (ESCIS25) of 200 mJ is based on the test conditions that is starting $T_J = 25^{\circ}\text{C}$, L = 3 mHy, ISCIS = 11.5 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during time in clamp.
- Self Clamped inductive Switching Energy (ESCIS150) of 125 mJ is based on the test conditions that is starting T_J = 150°C, L = 3mHy, ISCIS = 9.1 A, V_{CC} = 100 V during inductor charging and V_{CC} = 0 V during time in clamp.

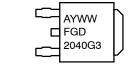
200 mJ, 400 V V_{CE(on)} = 1.6 V @ I_C = 6 A, V_{GE} = 4 V





DPAK (SINGLE GAUGE) CASE 369C

MARKING DIAGRAM



A = Assembly Location Y = Year

WW = Work Week FGD2040G3 = Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Max	Units
Junction-to-Case - Steady State (Drain)		1.2	°C/W

ELECTRICAL CHARACTERISTICS (T_{.1} = 25°C unless otherwise specified)

Symbol	Parameter	Test Co	nditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS			•			
BV _{CER}	Collector-to-Emitter Breakdown Voltage	I_{CE} = 2 mA, V_{GE} = 0 V, R_{GE} = 1 k Ω , T_{J} = -40 to 150°C		370	_	430	V
BV _{CES}	Collector-to-Emitter Breakdown Voltage	I_{CE} = 10 mA, V_{GE} = 0 V, R_{GE} = 0, T_{J} = -40 to 150°C		390	-	450	V
BV _{ECS}	Emitter-to-Collector Breakdown Voltage	$I_{CE} = -75 \text{ mA}, V_{GE} = 0 \text{ V},$ $T_{J} = 25^{\circ}\text{C}$		28	-	-	V
BV _{GES}	Gate-to-Emitter Breakdown Voltage	I _{GES} = ±2 mA		±12	±14	_	V
I _{CER}	Collector-to-Emitter Leakage Current	V _{CE} = 250 V	T _J = 25°C	-	-	25	μΑ
		$R_{GE} = 1 \text{ k}\Omega$	T _J = 150°C	-	-	1	mA
I _{ECS}	Emitter-to-Collector Leakage Current	V _{EC} = 24 V	T _J = 25°C	-	-	1	mA
			T _J = 150°C	-	-	40	
R ₁	Series Gate Resistance			-	144	_	Ω
R ₂	Series Gate Resistance			10K	-	26K	Ω
ON CHARA	ACTERISTICS						
V _{CE(SAT)}	Collector-to-Emitter Saturation Voltage	I _{CE} = 6 A, V _{GE} = 4 V, T _J = 25°C		_	1.34	1.6	V
V _{CE(SAT)}	Collector-to-Emitter Saturation Voltage	I _{CE} = 10 A, V _{GE} = 4.5 V, T _J = 150°C		-	1.86	2.1	V
DYNAMIC	CHARACTERISTICS						
Q _{G(ON)}	Gate Charge	I _{CE} = 10 A, V _{CE} = 12 V, V _{GE} = 5 V		_	14.9	_	nC
V _{GE(TH)}	Gate-to-Emitter Threshold Voltage	I _{CE} = 1 mA V _{CE} = V _{GE}	T _J = 25°C	1.3	1.6	2.2	V
			T _J = 150°C	0.75	1.2	1.8	1
V_{GEP}	Gate-to-Emitter Plateau Voltage	V _{CE} = 12 V	, I _{CE} = 10 A	-	4.3	_	V
SWITCHIN	G CHARACTERISTICS			•			
td _{(ON)R}	Current Turn-On Delay Time-Resistive	V_{CE} = 14 V, R_L = 1 Ω , V_{GE} = 5 V, R_G = 470 Ω , T_J = 25°C		_	0.4	1	μs
t _{rR}	Current Rise Time-Resistive			_	1.6	3	1
td _{(OFF)L}	Current Turn-Off Delay Time-Inductive	V_{CE} = 300 V, L = 1 mH, V_{GE} = 5 V, R_{G} = 470 Ω , I_{CE} = 6.5 A, T_{J} = 25°C		_	2.9	6	1
t _{fL}	Current Fall Time-Inductive			_	3.7	8	1

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

DEVICE ORDERING INFORMATION

Device	Package	Shipping [†]
FGD2040G3-F085	DPAK (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

TYPICAL CHARACTERISTICS

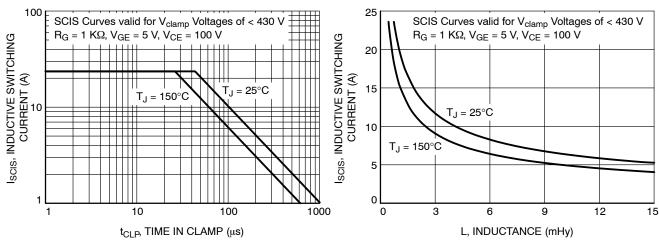


Figure 1. Self Clamped Inductive Switching **Current vs. Time in Clamp**

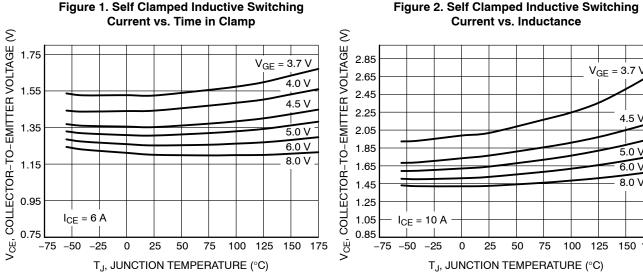


Figure 3. Collector-to-Emitter On-State Voltage vs. Junction Temperature

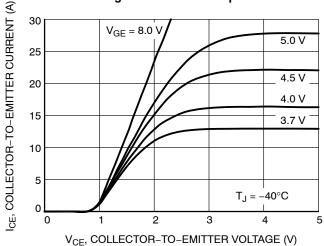
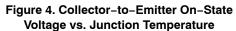


Figure 5. Collector-to-Emitter On-State Voltage vs. Collector Current



4.5 V

5.0 V

6.0 V 8.0 V

150 175

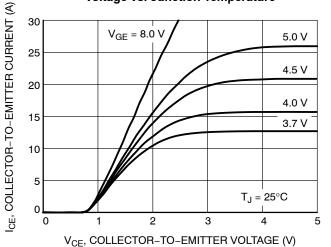


Figure 6. Collector-to-Emitter On-State Voltage vs. Collector Current

TYPICAL CHARACTERISTICS

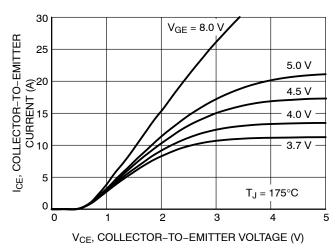


Figure 7. Collector-to-Emitter On-State Voltage vs. Collector Current

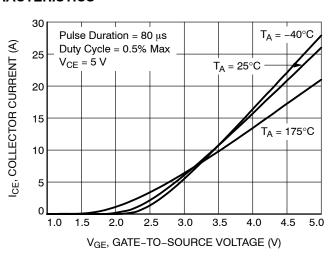


Figure 8. Transfer Characteristics

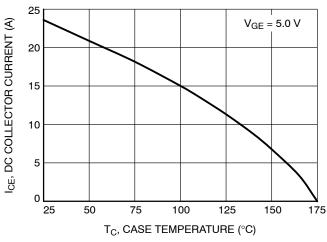


Figure 9. DC Collector Current vs. Case Temperature

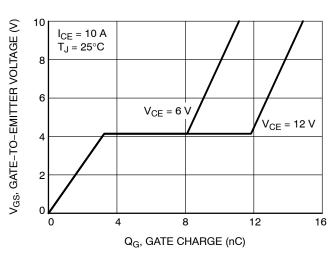


Figure 10. Gate Charge

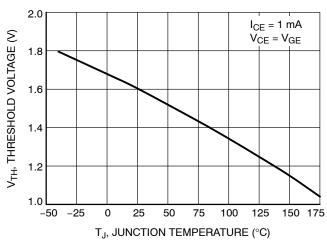


Figure 11. Threshold Voltage vs. Junction Temperature

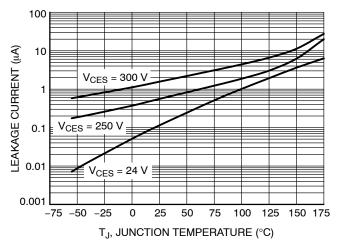


Figure 12. Leakage Current vs. Junction Temperature

TYPICAL CHARACTERISTICS

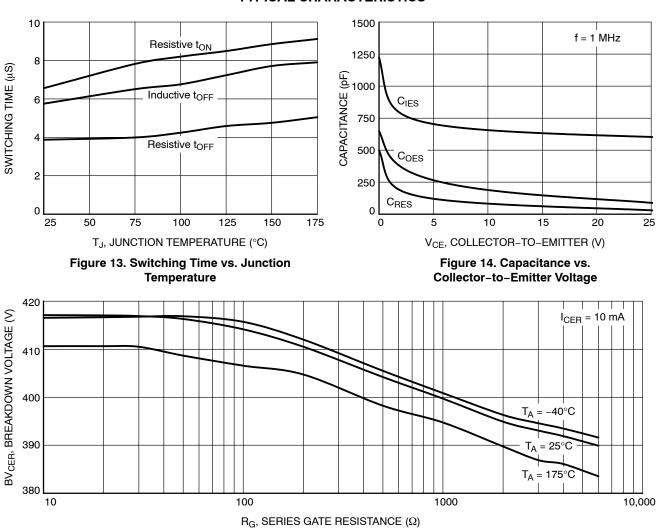


Figure 15. Break Down Voltage vs. Series Resistance

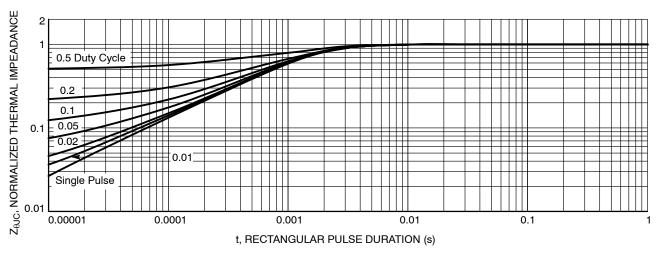
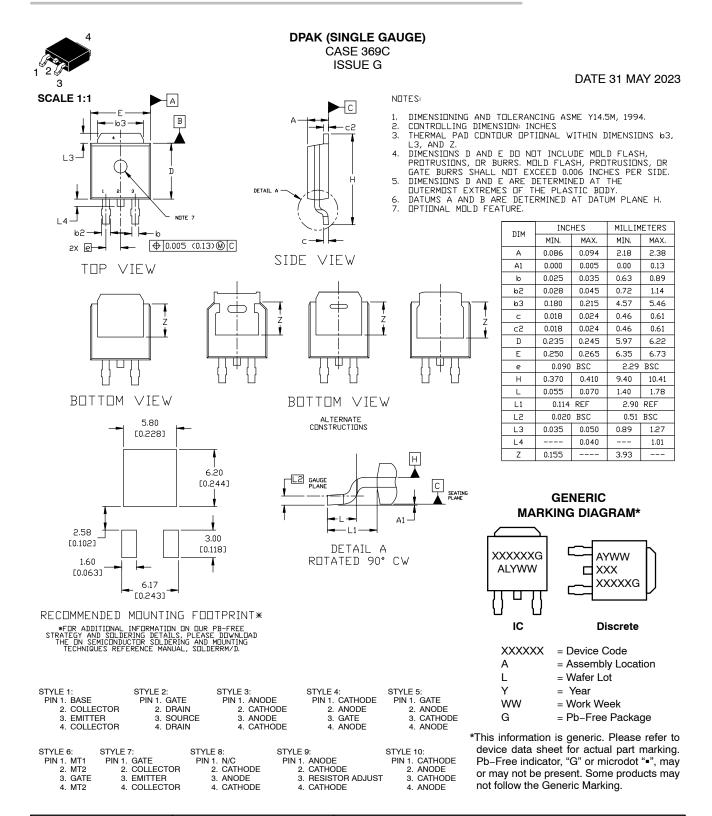


Figure 16. IGBT Normalized Transient Thermal Impedance, Junction-to-Case





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